

**A T 2 5 0 1 0 B - S S H L - B**

**Product Family**

25 = Standard SPI  
Serial EEPROM

**Device Density**

010 = 1-Kilobit  
020 = 2-Kilobit  
040 = 4-Kilobit

**Device Revision**

**Shipping Carrier Option**

B = Bulk (Tubes)

T = Tape and Reel, Standard Quantity Option

E = Tape and Reel, Extended Quantity Option

**Operating Voltage**

L = 1.8V to 5.5V

**Device Grade or  
Wafer/Die Thickness**

H or U = Industrial Temperature Range  
(-40°C to +85°C)

11 = 11mil Wafer Thickness

**Package Option**

SS = SOIC

X = TSSOP

MA = 2.0mm x 3.0mm UDFN

WWU = Wafer Unsawn

WDT = Die in Tape and Reel